TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74AC32P, TC74AC32F, TC74AC32FN, TC74AC32FT

QUAD 2-INPUT OR GATE

The TC74AC32 is an advanced high speed CMOS 2 - INPUT OR GATE fabricated with silicon gate and double - layer metal wiring C2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 2 stages including buffer output, which provide high noise immunity and stable output. All inputs are equipped with protection circuits against static discharge or transient excess voltage.

FEATURES:

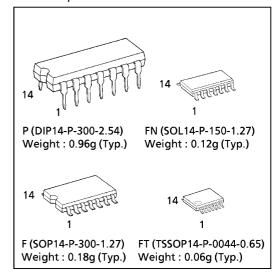
- High Speed------t_{pd} = 4.1ns (typ.) at V_{CC} = 5V
- Low Power Dissipation ·············· $I_{CC} = 4\mu A(Max.)$ at Ta = 25°C
- High Noise Immunity $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (Min.)

Capability of driving 50Ω transmission lines.

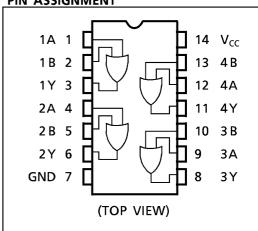
Balanced Propagation Delays ····· t_{pLH}≃t_{pHL}

- Wide Operating Voltage Range ···· V_{CC} (opr) = 2V ~ 5.5V
- Pin and Function Compatible with 74F32

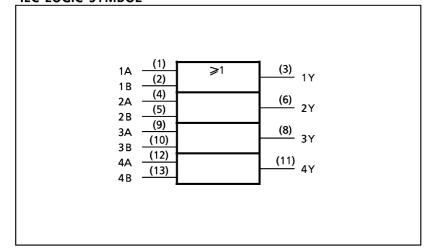
(Note) The JEDEC SOP (FN) is not available in Japan.



PIN ASSIGNMENT



IEC LOGIC SYMBOL



TRUTH TABLE

Α	В	Υ
Н	Н	Н
L	Н	Н
Н	L	Н
L	L	L

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V_{CC}	-0.5~7.0	٧
DC Input Voltage	V _{IN}	$-0.5 \sim V_{CC} + 0.5$	٧
DC Output Voltage	V _{OUT}	$-0.5 \sim V_{CC} + 0.5$	V
Input Diode Current	I _{IK}	± 20	mΑ
Output Diode Current	I _{OK}	± 50	mΑ
DC Output Current	I _{OUT}	± 50	mΑ
DC V _{cc} /Ground Current	I _{cc}	± 100	mΑ
Power Dissipation	P _D	500 (DIP)* / 180 (SOP/TSSOP)	mW
Storage Temperature	T _{stg}	−65~150	°C

*500mW in the range of Ta = -40° C~65°C. From Ta = 65°C to 85°C a derating factor of -10mW/°C should be applied up to 300mW.

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V_{cc}	2.0~5.5	٧
Input Voltage	VIN	0~V _{cc}	V
Output Voltage	V _{OUT}	0~V _{cc}	V
Operating Temperature	T _{opr}	−40~85	°C
Input Rise and Fall Time	dt/dV	$0 \sim 100 \text{ (Vcc} = 3.3 \pm 0.3 \text{V)}$ $0 \sim 20 \text{ (Vcc} = 5 \pm 0.5 \text{V)}$	ns / V

DC ELECTRICAL CHARACTERISTICS

PARAMETER SYMBO	CVAROL	TEST CONDITION		V _{cc}	Ta = 25°C			Ta = −40~85°C		UNIT
PARAMETER SYMBOL		TEST CONDITION		(V)	MIN.	TYP.	MAX.	MIN.	MAX.	וואוטן
High - Level Input Voltage	V _{IH}		2.0 3.0 5.5	1.50 2.10 3.85	_ _ _	_ _ _	1.50 2.10 3.85	_ _ _	٧	
Low - Level Input Voltage	VIL		2.0 3.0 5.5	 - -	_ _ _	0.50 0.90 1.65	_ 	0.50 0.90 1.65	٧	
High - Level Output Voltage	.,	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -50\mu A$	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	_ _ _	1.9 2.9 4.4	_ _ _	.,
	V _{OH}		$I_{OH} = -4mA$ $I_{OH} = -24mA$ $I_{OH} = -75mA*$	3.0 4.5 5.5	2.58 3.94 —	_ _ _	_ _ _	2.48 3.80 3.85	_ _ _	V
Low - Level Output Voltage	.,	V_{OL} $V_{IN} = V_{IL}$	$I_{OL} = 50 \mu A$	2.0 3.0 4.5	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1	_ 	0.1 0.1 0.1	v
	V _{OL}		$I_{OL} = 12mA$ $I_{OL} = 24mA$ $I_{OL} = 75mA*$	3.0 4.5 5.5		_ _ _	0.36 0.36 —	_ _ _	0.44 0.44 1.65	
Input Leakage Current	I _{IN}	$V_{ N} = V_{CC}$ or GND		5.5	1	_	±0.1	_	± 1.0	
Quiescent Supply Current	I _{cc}	$V_{IN} = V_{CC}$ or GND		5.5	_	_	4.0	_	40.0	μΑ

^{* :} This spec indicates the capability of driving 50Ω transmission lines. One output should be tested at a time for a 10ms maximum duration.

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AC ELECTRICAL CHARACTERISTICS (C_L = 50pF , $\,R_L$ = 500 Ω , Input $\,t_r$ = t_f = 3ns)

PARAMETER	SYMBOL	TEST CONDITION		Ta = 25°C			Ta = −40~85°C		UNIT
			V _{cc} (V)	MIN.	TYP.	MAX.	MIN.	MAX.	ONIT
Propagation Delay Time	t _{pLH} t _{pHL}	l I	3.3 ± 0.3 5.0 ± 0.5		6.1 5.2	10.3 7.4	1.0 1.0	11.9 8.5	ns
Input Capacitance	C _{IN}			_	5	10	_	10	рF
Power Dissipation Capacitance	C _{PD} (1)			_	64	_	_	_	μr

Note (1) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

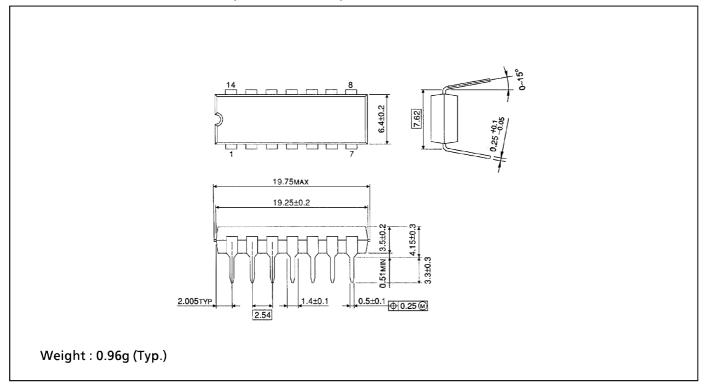
Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 4 \text{ (per Gate)}$$

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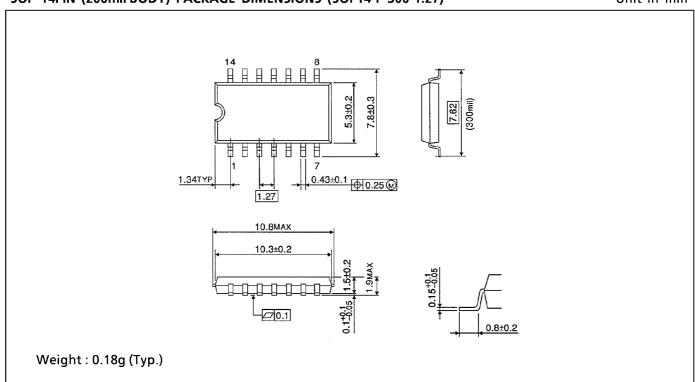
DIP 14PIN PACKAGE DIMENSIONS (DIP14-P-300-2.54)

Unit in mm



SOP 14PIN (200mil BODY) PACKAGE DIMENSIONS (SOP14-P-300-1.27)

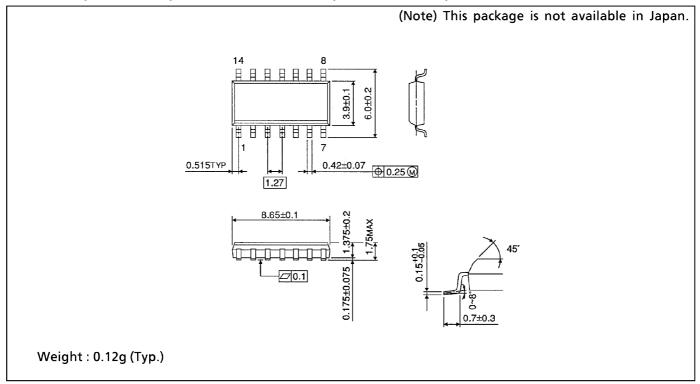
Unit in mm



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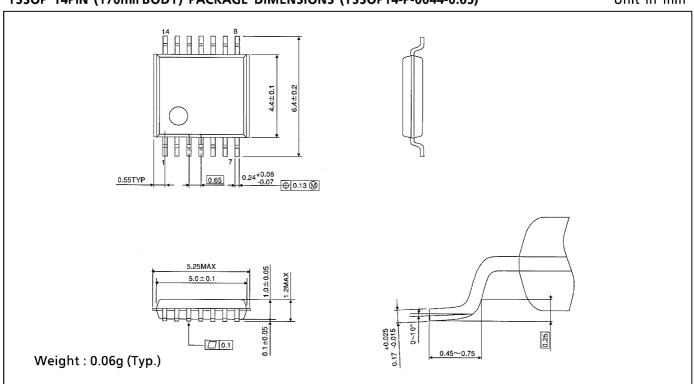
SOP 14PIN (150mil BODY) PACKAGE DIMENSIONS (SOL14-P-150 -1.27)

Unit in mm



TSSOP 14PIN (170mil BODY) PACKAGE DIMENSIONS (TSSOP14-P-0044-0.65)

Unit in mm



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